

N-Channel 60-V (D-S) MOSFET

CHARACTERISTICS

- N-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- · Level 3 MOS

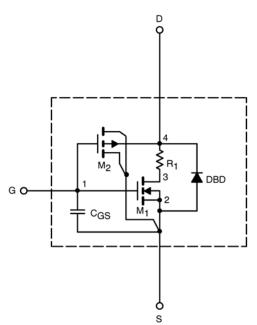
- Apply for both Linear and Switching Application
- Accurate over the -55 to 125°C Temperature Range
- Model the Gate Charge, Transient, and Diode Reverse Recovery Characteristics

DESCRIPTION

The attached spice model describes the typical electrical characteristics of the n-channel vertical DMOS. The subcircuit model is extracted and optimized over the -55 to 125° C temperature ranges under the pulsed 0-V to 10-V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage.

SUBCIRCUIT MODEL SCHEMATIC

A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched C_{gd} model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.



This document is intended as a SPICE modeling guideline and does not constitute a commercial product data sheet. Designers should refer to the appropriate data sheet of the same number for guaranteed specification limits.



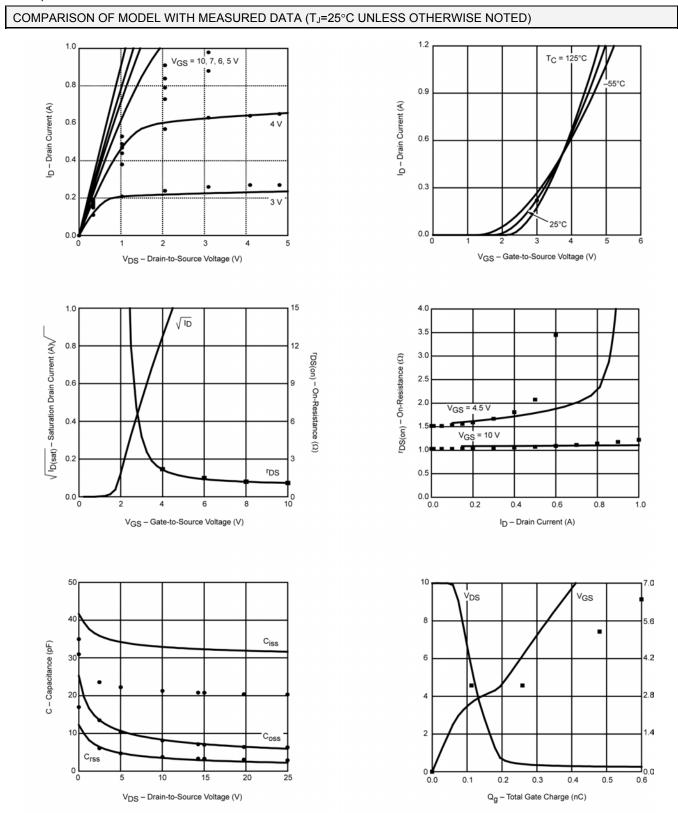
SPECIFICATIONS (T _J = 25°C UNLESS OTHERWISE NOTED)					
Parameter	Symbol	Test Condition	Simulated Data	Measured Data	Unit
Static			-		
Gate Threshold Voltage	V _{GS(th)}	V_{DS} = V_{GS} , I_D = -250 μ A	1.6		V
On-State Drain Current ^a	I _{D(on)}	V_{DS} = 5 V, V_{GS} = 10 V	4		А
Drain-Source On-State Resistance ^a	۲ _{DS(on)}	V_{GS} = 10 V, I _D = 0.25 A	1.1	1	Ω
		V_{GS} = 4.5 V, I _D = 0.20 A	1.6	1.4	
Forward Transconductance ^a	g _{fs}	V_{DS} = 10 V, I_{D} = 0.25 A	240	350	mS
Diode Forward Voltage ^a	V _{SD}	$I_{\rm S}$ = 0.23 A, $V_{\rm GS}$ = 0 V	0.85	0.83	V
Dynamic ^b			-		
Total Gate Charge	Qg	V_{DS} = 10 V, V_{GS} = 4.5 V, I _D = 0.25 A	0.30	0.40	nC
Gate-Source Charge	Q _{gs}		0.11	0.11	
Gate-Drain Charge	Q _{gd}		0.15	0.15	

Notes

a. Pulse test; pulse width \leq 300 μs , duty cycle \leq 2%. b. Guaranteed by design, not subject to production testing.



SPICE Device Model Si1330EDL Vishay Siliconix



Note: Dots and squares represent measured data.



Vishay

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